

Lonten N-channel 40V, 12A, 12mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- $40V,12A,R_{DS(ON).max}=12m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- Green device available

Applications

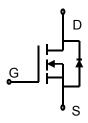
- Motor Drives
- ♦ UPS
- ♦ DC-DC Converter

Product Summary

 $\begin{array}{ll} V_{DSS} & \quad \ \, 40V \\ R_{DS(on).max} @ \ V_{GS} \text{=} 10V & \quad \, 12m\Omega \\ I_D & \quad \, 12A \end{array}$

Pin Configuration





N-Channel MOSFET

Pb

Absolute Maximum Ratings T_A= 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	40	V
Continuous drain current (T _A =25°C)		12	A
Continuous drain current (T _A = 100°C)	l _D	7.6	A
Pulsed drain current ¹⁾	I _{DM}	48	A
Gate-Source voltage	V _{GSS}	±20	V
Power Dissipation (T _A =25°C)	P _D	2.1	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	59.5	°C/W



Package Marking and Ordering Information

Device	Device Package	Marking
LNL04R120	SOP-8	LNL04R120

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	,					
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	40			V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		2.0	V
		V _{DS} =40 V, V _{GS} =0 V, T _J = 25°C			1	μA
Drain-source leakage current	I _{DSS}	V _{DS} =32 V, V _{GS} =0 V, T _J = 125°C			10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA
5.1		V _{GS} =10 V, I _D =12 A		9.2	12	mΩ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =8 A		11.8	16	mΩ
Forward transconductance	g _{fs}	V _{DS} =5 V , I _D =20A		35		S
Dynamic characteristics						•
Input capacitance	C _{iss}	V 00 V V 0 V		1370		
Output capacitance	Coss	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V},$		158		pF
Reverse transfer capacitance	Crss	- F = 1MHz		125		
Turn-on delay time	t _{d(on)}			14.5		
Rise time	t _r	$V_{DD} = 20V, V_{GS} = 10V, I_D = 12 A$		19.2		ns
Turn-off delay time	t _{d(off)}	VDD - 20V,VGS-10V, ID - 12 A		61		115
Fall time	t _f			27		1
Gate resistance	Rg	V _{GS} =0V, V _{DS} =0V, F=1MHz		3.5		Ω
Gate charge characteristics	•					•
Gate to source charge	Q _{gs}			7.1		
Gate to drain charge	Q _{gd}	V _{DS} =20V, I _D =12A,		2.9		nC
Gate charge total	Qg	- V _{GS} = 10V		27.5		
Drain-Source diode characteristi	cs and Maxii	mum Ratings				•
Continuous Source Current	Is				12	Α
Pulsed Source Current ³⁾	I _{SM}				48	Α
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =10A, T _J =25℃			1.2	V
Reverse Recovery Time	t _{rr}	1 400 didt 4000//- T 05°C		21		ns
Reverse Recovery Charge	Qrr	- I _S =12A,di/dt=100A/us, T _J =25℃		7.8		nC

Notes:

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^{1:} Repetitive Rating: Pulse width limited by maximum junction temperature.

^{2:} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.



Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

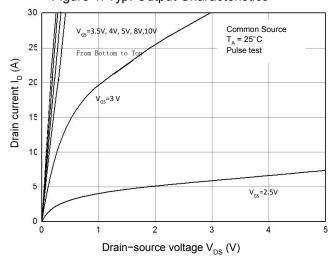


Figure 2. Transfer Characteristics

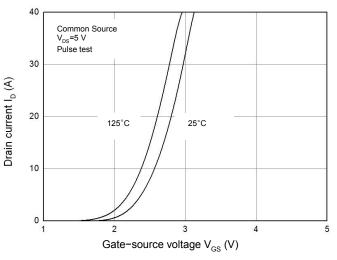


Figure 3. Capacitance Characteristics

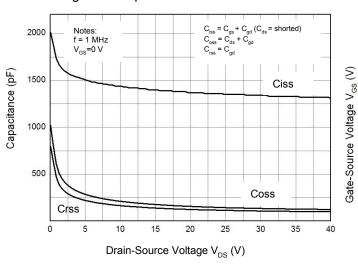


Figure 4. Gate Charge Waveform

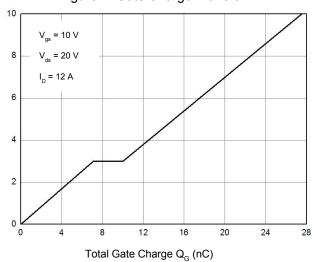


Figure 5. Body-Diode Characteristics

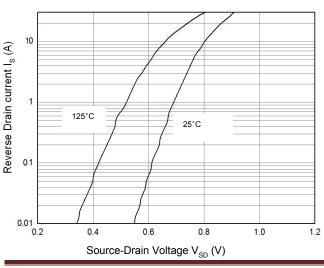
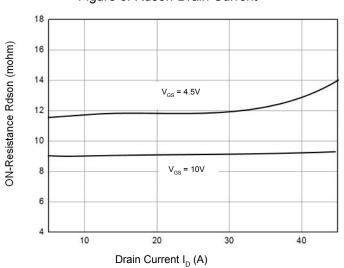
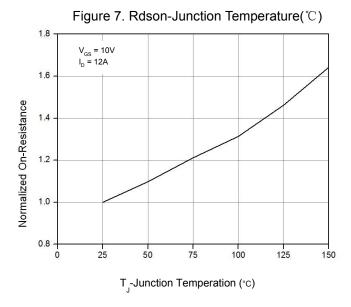


Figure 6. Rdson-Drain Current







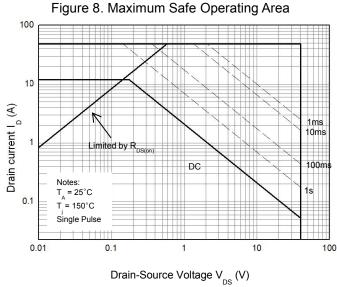
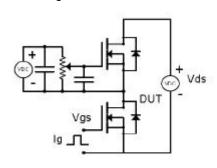


Figure 9. Normalized Maximum Transient Thermal Impedance (RthJA) 10 D=Ton/T In descending oder $T_{J,PK} = T_A + P_{DM} \cdot Z_{\theta JA} \cdot R_{\theta JA}$ D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse $\mathsf{L}_{\mathrm{dJA}} \quad \text{Normalized Transient} \\ \text{Thermal Resistance}$ 1 0.1 Po Single Pulse 0.01 1000 1E-5 1E-4 1E-3 0.01 0.1 1 10 100 Pulse Width t (s)



Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



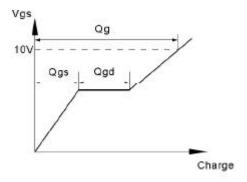
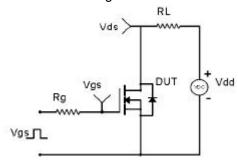


Figure 9. Resistive Switching Test Circuit & Waveforms



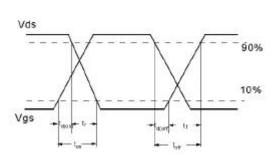
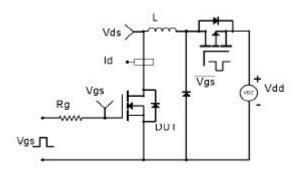


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



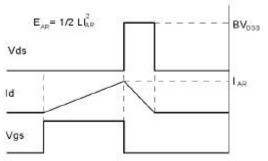
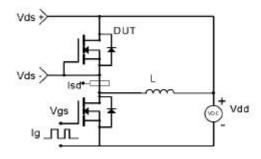
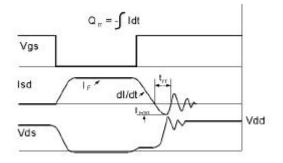


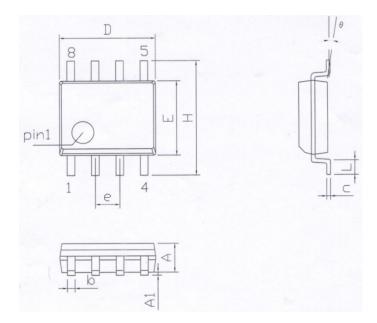
Figure 11. Diode Recovery Circuit & Waveform





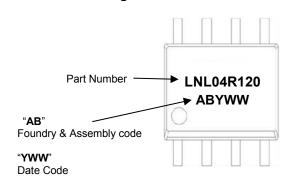


Mechanical Dimensions for SOP-8



COMMON DIMENSIONS					
SYMBOL	MILLIMETERS		INCHS		
	MIN	MAX	MIN	MAX	
Α	1.35	1.65	0.053	0.065	
A1	0.10	0.25	0.004	0.010	
b	0.35	0.50	0.014	0.020	
С	0.19	0.27	0.007	0.011	
D	4.80	5.10	0.189	0.201	
E	3.80	4.10	0.150	0.161	
е	1.22	1.32	0.048	0.052	
Н	5.80	6.20	0.228	0.244	
L	0.60	0.90	0.024	0.035	
θ	0°	8°	0°	8°	

SOP-8 Part Marking Information





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